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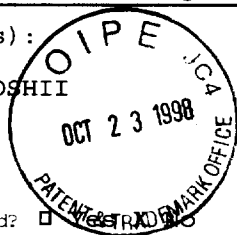
R SHEET

U.S. DEPARTMENT OF COMMERCE  
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To Honorable Commissioner of Patents and Trademarks: OHS-231CIP  
Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):  
Keiko KATSUKI and Makoto YOSHII



2. Name and address of receiving party(ies)  
Name: Kyowa Chemical Industry Co., Ltd.

Internal Address: \_\_\_\_\_

Street Address: 305, Yashimanishi-machi,

Takamatsu-shi

Kagawa 761-01, Japan

Additional name(s) & addresses attached?

Additional name(s) & addresses attached?  Yes  No

3. Nature of Conveyance:

- Assignment  Merger
- Security Agreement  Change of Name
- Other \_\_\_\_\_

Execution Date 05/07/98

4. Application number(s) or patent number(s): 09/044,004  
If this document is being filed together with a new application,  
the execution date of the application is: \_\_\_\_\_

A. Patent Application No. (s)

B. Patent No. (s)

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: SHERMAN & SHALLOWAY

Internal Address: \_\_\_\_\_

Street Address: 413 North Washington Street

City: Alexandria State: VA ZIP: 22314

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).... \$ 40.00

Enclosed

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8. Deposit account number: 19-1980

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9. Statement and Signature.  
*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

Perry Carvellas  
Name of Person Signing

Perry Carvellas  
Signature

October 23, 1998  
Date

Total number of pages including cover sheet, attachments, and document:

2

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PATENT  
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## A S S I G N M E N T

WHEREAS, We, Keiko KATSUKI and Makoto YOSHII  
residing at Sakaide-shi, KAGAWA, JAPAN, respectively,

(hereinafter referred to as Inventors), have invented certain new and useful improvements in HEAT DETERIORATION RESISTANT FLAME RETARDANT, RESIN COMPOSITION AND MOLDED ARTICLES; for which an application for United States Letters Patent was signed by us on March 10, 1998 and filed in the United States on March 19, 1998 and assigned Serial Number 09/044,004.

WHEREAS, KYOWA CHEMICAL INDUSTRY CO., LTD. a corporation of Japan, having a place of business at 305, Yashimanishi-machi, Takamatsu-shi, Kagawa 761-01, JAPAN (hereinafter referred to as Company), is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, the receipt whereof is hereby acknowledged, and other valuable considerations, the said Inventors have sold, assigned and transferred, and by the presents does sell, assign and transfer unto said Company, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent, which may be granted thereof in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations and extensions thereof.

We hereby authorize and request the Patent Office officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to said Company as the assignee of the entire right, title and interest in and to the same, for the sole use and behoof of the said Company, its successors and assigns.

FURTHER, we agree that we will communicate to said Company or its representatives any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitution, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said Company, make all rightful oaths and generally do everything possible to aid said Company, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, we have hereunto set our hands this 7<sup>th</sup>  
   day of May, 1998.

Signed in the presence of:

Witness: Satoko Yamashita

Signed: Keiko Katsuki  
Keiko KATSUKI

Witness: Mayumi Hirayama

Signed: Makoto Yoshii  
Makoto YOSHII